503077839 11/26/2014

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3124443

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
BINITA GUPTA	11/11/2014
GREGORY BURNS	10/21/2014
JACK PROFIT	10/24/2014

RECEIVING PARTY DATA

Name:	QUALCOMM INNOVATION CENTER, INC.	
Street Address:	5775 MOREHOUSE DRIVE	
City:	SAN DIEGO	
State/Country:	CALIFORNIA	
Postal Code:	92121-1714	

PROPERTY NUMBERS Total: 2

Property Type	Number
Application Number:	61839801
Application Number:	14316254

CORRESPONDENCE DATA

Fax Number: (720)536-4910

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 720.536.4900

Email: rene@nodiplaw.com

Correspondent Name: NEUGEBOREN O'DOWD PC
Address Line 1: 1227 SPRUCE STREET

Address Line 2: SUITE 200

Address Line 4: BOULDER, COLORADO 80302

ATTORNEY DOCKET NUMBER:	133034 133034P1
NAME OF SUBMITTER:	SEAN R. O'DOWD
SIGNATURE:	/Sean R. O'Dowd/
DATE SIGNED:	11/26/2014

Total Attachments: 9

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ASSIGNMENT

WHEREAS, WE,

- 1. Binita Gupta, a citizen of India (IN), having a mailing address located at Qualcomm Incorporated, 5775 Morehouse Dr., San Diego, CA 92121, and a resident of San Diego, CA,
- 2. Gregory Burns, a citizen of the United States of America (US), having a mailing address located at Qualcomm Incorporated, 5775 Morehouse Dr., San Diego, CA 92121 and a resident of Seattle, WA,
- 3. **Jack Profit,** a citizen of the United States of America (US), having a mailing address located at Qualcomm Incorporated, 5775 Morehouse Dr., San Diego, CA 92121 and a resident of Vashon, WA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to LEVERAGING SYSTEM SIGNALING SERVICE ADVERTISEMENTS FOR APPLICATION-LAYER DISCOVERY AND CONNECTION MANAGEMENT IN AN INTERNET OF THINGS (IoT) ENVIRONMENT (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, Qualcomm Innovation Center, Inc. (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/316,254 filed June 26, 2014, Qualcomm Reference No. 133034, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/839,801, filed June 26, 2013, Qualcomm Reference No. 133034P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

PATENT QUALCOMM Ref. No. 133034 Page 3 of 3

Done at	San Diego (A)	n_{ 1	トランシュー Binita Gupta	***************************************
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	LOCATION	DAIR	Gregory Burns	
Done at		n		
en many pay	LOCATION	DATE	Jack Profit	

ASSIGNMENT

WHEREAS, WE,

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AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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PATENT QUALCOMM Ref. No. 133034 Page 3 of 3

Done at _)II	
	LOCATION	DATE	Binita Gupta
Done at S	Sectle.	m 10/21/14	and
	LOCATION ,	bark	Gregory Burns
Done at _	· · · · · · · · · · · · · · · · · · ·	on	
	LOCATION	DATE	Jack Profit

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PATENT QUALCOMM Ref. No. 133034 Page 3 of 3

Done at	, on		
	LOCATION	DATE	Binita Gupta
Done at	, on		
	LOCATION	DATE	Gregory Burns
Done at	Deattle Wron	10124114	<u> </u>
	LOCATION	DATE	/ Jack/Profit

PATENT REEL: 034269 FRAME: 0717

RECORDED: 11/26/2014